# FAMILY OF NANOPOWER OPERATIONAL AMPLIFIERS AND PUSH－PULL COMPARATORS 

## FEATURES

－Micro－Power Operation．．． $1.4 \mu \mathrm{~A}$
－Input Common－Mode Range Exceeds the Rails ．．．－0．1 V to VCC +5 V
－Supply Voltage Range ．．．2．5 V to 16 V
－Rail－to－Rail Input／Output（Amplifier）
－Reverse Battery Protection Up to 18 V
－Gain Bandwidth Product ．．． 5.5 kHz （Amplifier）
－Push－Pull CMOS Output Stage（Comparator）
－Specified Temperature Range
$-\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ ．．．Industrial Grade
－Ultrasmall Packaging
－8－Pin MSOP（TLV2702）
－Universal Op－Amp EVM（See the SLOU060 For More Information）

## APPLICATIONS

－Portable Battery Monitoring
－Consumer Medical Electronics
－Security Detection Systems

## DESCRIPTION

The TLV270x combines sub－micropower operational amplifier and comparator into a single package that produces excellent micropower signal conditioning with only $1.4 \mu \mathrm{~A}$ of supply current．This combination gives the designer more board space and reduces part counts in systems that require an operational amplifier and comparator．The low supply current makes it an ideal choice for battery powered portable applications where quiescent current is the primary concern．Reverse battery protection guards the amplifier from an over－current condition due to improper battery installation．For harsh environments，the inputs can be taken 5 V above the positive supply rail without damage to the device．

The TLV270x＇s low supply current is coupled with extremely low input bias currents enabling them to be used with mega－ohm resistors making them ideal for portable，long active life，applications．DC accuracy is ensured with a low typical offset voltage as low as $390 \mu \mathrm{~V}$ ，CMRR of 90 dB ，and minimum open loop gain of $130 \mathrm{~V} / \mathrm{mV}$ at 2.7 V ．

The maximum recommended supply voltage is as high as 16 V and ensured operation down to 2.5 V ，with electrical characteristics specified at $2.7 \mathrm{~V}, 5 \mathrm{~V}$ ，and 15 V ．The $2.5-\mathrm{V}$ operation makes it compatible with Li－Ion battery－powered systems and many micro－power microcontrollers available today including TI＇s MSP430．

All members are available in PDIP and SOIC with the duals，one op－amp and one comparator，in the small MSOP package and quads，two operational amplifiers and two comparators，in the TSSOP package．


SUPPLY CURRENT
vs


Please be aware that an important notice concerning availability，standard warranty，and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet．

## A SELECTION OF OUTPUT COMPARATORS $\dagger$

| DEVICE | $\mathbf{V}_{\mathbf{C C}}$ <br> $(\mathbf{V})$ | $\mathbf{V}_{\mathbf{I O}}$ <br> $(\mu \mathbf{V})$ | $\mathbf{I} \mathbf{C C} / \mathbf{C h}$ <br> $(\mu \mathbf{A})$ | $\mathbf{G B W}$ <br> $(\mathbf{k H z})$ | $\mathbf{S R}$ <br> $(\mathbf{V} / \mu \mathbf{s})$ | $\mathbf{t} \mathbf{P L H}$ <br> $(\mu \mathbf{s})$ | $\mathbf{t P H L}_{(\mu \mathbf{s})}$ | $\mathbf{t}_{\mathbf{f}}$ <br> $(\mu \mathbf{s})$ | RAIL-TO- <br> RAIL | OUTPUT <br> STAGE |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TLV270x | $2.5-16$ | 390 | $1.4 \ddagger$ | 5.5 | 0.0025 | 56 | 83 | 8 | $\mathrm{I} / \mathrm{O}$ | PP |
| TLV230x | $2.5-16$ | 390 | $1.4 \ddagger$ | 5.5 | 0.0025 | 55 | 30 | 5 | $\mathrm{I} / \mathrm{O}$ | OD |
| TLV240x | $2.5-16$ | 390 | 880 | 5.5 | 0.0025 | - | - | - | $\mathrm{I} / \mathrm{O}$ | - |
| TLV224x | $2.5-12$ | 600 | 1 | 5.5 | 0.002 | - | - | - | $\mathrm{I} / \mathrm{O}$ | - |
| TLV340x | $2.5-16$ | 250 | 0.47 | - | - | 55 | 30 | 5 | I | OD |
| TLV370x | $2.5-16$ | 250 | 0.56 | - | - | 56 | 83 | 8 | I | PP |

$\dagger$ All specifications are typical values measured at 5 V .
$\ddagger$ ICC is specified as one op-amp and one comparator.
TLV2702 AVAILABLE OPTIONS

| $\mathrm{T}_{\mathbf{A}}$ | $V_{\text {IO max }}$ <br> AT $25^{\circ} \mathrm{C}$ | PACKAGED DEVICES |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | SMALL OUTLINE $\dagger$ <br> (D) | MSOP |  | PLASTIC DIP <br> (P) |
|  |  |  | $\begin{gathered} \hline \text { MSOP } \dagger \\ \text { (DGK) } \end{gathered}$ | SYMBOLS |  |
| $-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$ | $4000 \mu \mathrm{~V}$ | TLV2702ID | TLV2702IDGK | xxTIAQF | TLV2702IP |

$\dagger$ This package is available taped and reeled. To order this packaging option, add an R suffix to the part number (e.g., TLV2702IDR).

TLV2704 AVAILABLE OPTIONS

| $\mathbf{T}_{\mathbf{A}}$ | $\mathbf{V}_{\text {IOmax }}$ <br> AT $25^{\circ} \mathrm{C}$ | PACKAGED DEVICES |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | SMALL OUTLINE <br> (D) | TSSOP <br> (PW) | PLASTIC DIP <br> (N) |  |
|  | $4000 \mu \mathrm{~V}$ | TLV2704ID | TLV2704IPW | TLV2704IN |  |

$\dagger$ This package is available taped and reeled. To order this packaging option, add an R suffix to the part number (e.g., TLV2704IDR).

## TLV270x PACKAGE PINOUTS



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted) $\dagger$


Differential input voltage, $\mathrm{V}_{\mathrm{ID}}$



Continuous total power dissipation See Dissipation Rating Table
Operating free-air temperature range, $T_{A}$ : I suffix ................................................. $40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$


Lead temperature $1,6 \mathrm{~mm}(1 / 16 \mathrm{inch})$ from case for 10 seconds ....................................... $260^{\circ} \mathrm{C}$
$\dagger$ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
NOTES: 1. All voltage values, except differential voltages, are with respect to GND
2. Input voltage range is limited to 20 V max or $\mathrm{V}_{\mathrm{CC}}+5 \mathrm{~V}$, whichever is smaller.

DISSIPATION RATING TABLE

| PACKAGE | $\Theta_{\mathbf{J C}}$ <br> $\left({ }^{\circ} \mathbf{C} / \mathbf{W}\right)$ | $\Theta_{\mathbf{J A}}$ <br> $\left({ }^{\circ} \mathbf{C} / \mathbf{W}\right)$ | $\mathbf{T}_{\mathbf{A}} \leq \mathbf{2 5}{ }^{\circ} \mathbf{C}$ <br> POWER RATING | $\mathbf{T}_{\mathbf{A}}=\mathbf{1 2 5}{ }^{\circ} \mathbf{C}$ <br> POWER RATING |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{D}(8)$ | 38.3 | 176 | 710 mW | 142 mW |
| $\mathrm{D}(14)$ | 26.9 | 122.3 | 1022 mW | 204.4 mW |
| $\mathrm{DGK}(8)$ | 54.2 | 259.9 | 481 mW | 96.2 mW |
| $\mathrm{~N}(14)$ | 32 | 78 | 1600 mW | 320.5 mW |
| $\mathrm{P}(8)$ | 41 | 104 | 1200 mW | 240.4 mW |
| $\mathrm{PW}(14)$ | 29.3 | 173.6 | 720 mW | 144 mW |

recommended operating conditions

|  |  | MIN | MAX | UNIT |
| :--- | :--- | ---: | ---: | :---: |
| Supply voltage, $\mathrm{V}_{\mathrm{CC}}$ | Single supply | 2.5 | 16 | V |
|  | Split supply | $\pm 1.25$ | $\pm 8$ |  |
| Common-mode input voltage range, $\mathrm{V}_{\text {ICR }}$ | Amplifier and comparator | -0.1 | $\mathrm{~V}_{\mathrm{CC}}+5$ | V |
| Operating free-air temperature, $\mathrm{T}_{\mathrm{A}}$ |  | -40 | 125 | ${ }^{\circ} \mathrm{C}$ |

## electrical characteristics at recommended operating conditions, $\mathrm{V}_{\mathrm{CC}}=2.7,5 \mathrm{~V}$, and 15 V (unless otherwise noted)

amplifier dc performance

|  | PARAMETER | TEST CONDITIONS |  | TA ${ }^{\dagger}$ | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{10}$ | Input offset voltage | $\mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CC}} / 2 \mathrm{~V}, \quad \mathrm{~V}_{\mathrm{IC}}=\mathrm{V}_{\mathrm{CC}} / 2 \mathrm{~V}, \quad \mathrm{R}_{\mathrm{S}}=50 \Omega$ |  | $25^{\circ} \mathrm{C}$ |  | 390 | 4000 | $\mu \mathrm{V}$ |
|  |  |  |  | Full range | 6000 |  |  |  |
| $\alpha \mathrm{VIO}$ Offset voltage draft |  |  |  | $25^{\circ} \mathrm{C}$ | 3 |  |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| CMRR Common-mode rejection ratio |  | $\mathrm{V}_{\text {IC }}=0$ to $\mathrm{V}_{\mathrm{CC}}, \mathrm{R}_{\mathrm{S}}=50 \Omega$ | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ | $25^{\circ} \mathrm{C}$ | 55 | 73 |  | dB |
|  |  | Full range |  | 52 |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$ | $25^{\circ} \mathrm{C}$ | 60 | 80 |  |  |  |
|  |  | Full range | 55 |  |  |  |  |
|  |  | $V_{C C}=15 \mathrm{~V}$ | $25^{\circ} \mathrm{C}$ | 66 | 90 |  |  |  |
|  |  | Full range | 60 | 90 |  |  |  |
| AvD | Large-signal differential voltage amplification |  | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}, \mathrm{~V}_{(0 \mathrm{pp})}=1.5 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=500 \mathrm{k} \Omega$ |  | $25^{\circ} \mathrm{C}$ | 130 | 400 |  | V/mV |
|  |  | Full range |  |  | 30 |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}, \quad \mathrm{~V}_{\mathrm{O}}(\mathrm{pp})=3 \mathrm{~V}, \quad \mathrm{R}_{\mathrm{L}}=500 \mathrm{k} \Omega$ |  | $25^{\circ} \mathrm{C}$ | 300 | 1000 |  |  |  |
|  |  |  |  | Full range | 100 |  |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=15 \mathrm{~V}, \quad \mathrm{~V}_{\mathrm{O}(\mathrm{pp})}=8 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=500 \mathrm{k} \Omega$ |  | $25^{\circ} \mathrm{C}$ | 400 | 1800 |  |  |  |
|  |  |  |  | Full range | 120 |  |  |  |  |
| PSRR | Power supply rejection ratio$\left(\Delta \mathrm{V}_{\mathrm{CC}} / \Delta \mathrm{V}_{I O}\right)$ | V IC $=\mathrm{V}_{\text {CC }} / 2 \mathrm{~V}$, No load | $\mathrm{V}_{\mathrm{CC}}=2.7$ to 5 V | $25^{\circ} \mathrm{C}$ | 90 | 120 |  | dB |  |
|  |  |  |  | Full range | 85 |  |  |  |  |
|  |  |  | $\mathrm{V}_{\mathrm{CC}}=5$ to 15 V | $25^{\circ} \mathrm{C}$ | 94 | 120 |  |  |  |
|  |  |  |  | Full range | 90 |  |  |  |  |

$\dagger$ Full range is $-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$.
amplifier and comparator input characteristics

|  | PARAMETER | TEST CONDITIONS | $\mathrm{T}_{\mathbf{A}}{ }^{\dagger}$ | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 I | Input offset current | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CC}} / 2 \mathrm{~V}, \quad \mathrm{~V}_{\mathrm{IC}}=\mathrm{V}_{\mathrm{CC}} / 2 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{S}}=50 \Omega \end{aligned}$ | $25^{\circ} \mathrm{C}$ |  | 25 | 250 | pA |
|  |  |  | 0 to $70^{\circ} \mathrm{C}$ |  |  | 300 |  |
|  |  |  | Full range |  |  | 700 |  |
| IB | Input bias current |  | $25^{\circ} \mathrm{C}$ |  | 100 | 500 | pA |
|  |  |  | 0 to $70^{\circ} \mathrm{C}$ |  |  | 550 |  |
|  |  |  | Full range |  |  | 1700 |  |
| $\mathrm{r}_{\mathrm{i}}(\mathrm{d})$ | Differential input resistance |  | $25^{\circ} \mathrm{C}$ |  | 300 |  | $\mathrm{M} \Omega$ |
| $\mathrm{C}_{\mathrm{i}(\mathrm{c})}$ | Common-mode input capacitance | $\mathrm{f}=100 \mathrm{kHz}$ | $25^{\circ} \mathrm{C}$ |  | 3 |  | pF |

$\dagger$ Full range is $-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$.

## electrical characteristics at recommended operating conditions, $\mathrm{V}_{\mathrm{CC}}=2.7,5 \mathrm{~V}$, and 15 V (unless otherwise noted) (continued)

amplifier output characteristics

| PARAMETER | TEST CONDITIONS |  | $\mathrm{T}_{\mathbf{A}}{ }^{\text {t }}$ | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| V OH High-level | $\begin{aligned} & \mathrm{V}_{\mathrm{IC}}=\mathrm{V}_{\mathrm{CC}} / 2, \\ & \mathrm{IOH}=-50 \mu \mathrm{~A} \end{aligned}$ |  | $25^{\circ} \mathrm{C}$ | 2.55 | 2.65 |  | V |
|  |  | $V_{C C}=2.7$ | Full range | 2.5 |  |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$ | $25^{\circ} \mathrm{C}$ | 4.85 | 4.95 |  |  |
|  |  |  | Full range | 4.8 |  |  |  |
|  |  | $\mathrm{V}_{C C}=15 \mathrm{~V}$ | $25^{\circ} \mathrm{C}$ | 14.8 | 14.95 |  |  |
|  |  |  | Full range | 14.8 |  |  |  |
| VOL Low-level output voltage | $\mathrm{V}_{\mathrm{IC}}=\mathrm{V}_{\mathrm{CC}} / 2, \quad \mathrm{IOL}=50 \mu \mathrm{~A}$ |  | $25^{\circ} \mathrm{C}$ |  | 180 | 260 | mV |
|  |  |  | Full range |  |  | 300 |  |
| IO Output current | $\mathrm{V}_{\mathrm{O}}=0.5 \mathrm{~V}$ from rail |  | $25^{\circ} \mathrm{C}$ |  | $\pm 200$ |  | $\mu \mathrm{A}$ |
| $\mathrm{Z}_{\mathrm{O}} \quad$ Closed-loop output impedance | $\mathrm{f}=100 \mathrm{~Hz}$, | $A_{V}=10$ | $25^{\circ} \mathrm{C}$ |  | 1.2 |  | k $\Omega$ |

$\dagger$ Full range is $-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$.
amplifier dynamic performance

supply current

|  | PARAMETER | TEST CONDITIONS |  | TA ${ }^{\dagger}$ | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ${ }^{\text {ICC }}$ | Supply current (one op-amp and one comparator) | $\mathrm{V}_{\mathrm{O}}=\mathrm{V}_{\mathrm{CC}} / 2$ | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ or 5 V | $25^{\circ} \mathrm{C}$ |  | 1.4 |  | $\mu \mathrm{A}$ |
|  |  |  | $\mathrm{V}_{\mathrm{CC}}=15 \mathrm{~V}$ | $25^{\circ} \mathrm{C}$ |  | 1.4 | 1.9 |  |
|  |  |  |  | Full range |  |  | 3.7 |  |
|  | Reverse supply current | $\mathrm{V}_{\mathrm{CC}}=-18 \mathrm{~V}, \mathrm{~V}_{\mathrm{I}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{O}}=$ open |  | $25^{\circ} \mathrm{C}$ |  | 50 |  | nA |

$\dagger$ Full range is $-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$.
electrical characteristics at recommended operating conditions, $\mathrm{V}_{\mathrm{CC}}=2.7,5 \mathrm{~V}$, and 15 V (unless otherwise noted) (continued)
comparator dc performance

|  | PARAMETER | TEST CONDITIONS $\dagger$ |  | TA ${ }^{\dagger}$ | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{10}$ | Input offset voltage | $\mathrm{V}_{\mathrm{IC}}=\mathrm{V}_{\mathrm{CC}} / 2, \quad \mathrm{R} \mathrm{S}=50 \Omega$ |  | $25^{\circ} \mathrm{C}$ |  | 250 | 5000 | $\mu \mathrm{V}$ |
|  |  |  |  | Full range |  |  | 7000 |  |
| $\alpha \mathrm{VIO}$ | Offset voltage drift |  |  | $25^{\circ} \mathrm{C}$ |  | 3 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| CMRR | Common-mode rejection ratio | $\begin{aligned} & \mathrm{V}_{I C}=0 \text { to } \mathrm{V}_{\mathrm{CC}}, \\ & \mathrm{R}_{\mathrm{S}}=50 \Omega \end{aligned}$ | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ | $25^{\circ} \mathrm{C}$ | 55 | 72 |  | dB |
|  |  |  |  | Full range | 50 |  |  |  |
|  |  |  | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$ | $25^{\circ} \mathrm{C}$ | 60 | 76 |  |  |
|  |  |  |  | Full range | 55 |  |  |  |
|  |  |  | $V_{C C}=15 \mathrm{~V}$ | $25^{\circ} \mathrm{C}$ | 65 | 88 |  |  |
|  |  |  |  | Full range | 60 |  |  |  |
| AvD | Large-signal differential voltage amplification |  |  | $25^{\circ} \mathrm{C}$ |  | 1000 |  | V/mV |
| PSRR | Power supply rejection ratio $\left(\Delta \mathrm{V}_{\mathrm{CC}} / \Delta \mathrm{V}_{\mathrm{IO}}\right)$ | $\mathrm{V}_{I C}=\mathrm{V}_{\mathrm{CC}} / 2 \mathrm{~V},$ <br> No load | $\mathrm{V}_{\mathrm{CC}}=2.7$ to 5 V | $25^{\circ} \mathrm{C}$ | 75 | 100 |  | dB |
|  |  |  |  | Full range | 70 |  |  |  |
|  |  |  | $V_{C C}=5$ to 15 V | $25^{\circ} \mathrm{C}$ | 85 | 105 |  |  |
|  |  |  |  | Full range | 80 |  |  |  |

$\dagger$ Full range is $-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$.
comparator output characteristics

|  | PARAMETER | TEST CONDITIONS $\dagger$ | $\mathrm{T}_{\mathbf{A}}{ }^{\dagger}$ | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{r}_{\mathrm{i}}(\mathrm{d})$ | Differential input resistance |  | $25^{\circ} \mathrm{C}$ |  | 300 |  | $\mathrm{M} \Omega$ |
| VOH | High-level output voltage | $\begin{aligned} & \mathrm{V}_{\mathrm{IC}}=\mathrm{V}_{\mathrm{CC}} / 2, \quad \mathrm{I} \mathrm{OL}=-50 \mu \mathrm{~A}, \\ & \mathrm{~V}_{\mathrm{ID}}=1 \mathrm{~V} \end{aligned}$ | $25^{\circ} \mathrm{C}$ | $\mathrm{V}_{\mathrm{CC}}-320$ |  |  | mV |
|  |  |  | Full range | $\mathrm{V}_{\mathrm{CC}}-450$ |  |  |  |
| $\mathrm{V}_{\mathrm{OL}}$ | Low-level output voltage | $\begin{aligned} & \mathrm{V}_{\mathrm{IC}}=\mathrm{V}_{\mathrm{CC}} / 2, \quad \mathrm{IOL}=50 \mu \mathrm{~A}, \\ & \mathrm{~V}_{\mathrm{ID}}=-1 \mathrm{~V} \end{aligned}$ | $25^{\circ} \mathrm{C}$ |  | 80 | 200 | mV |
|  |  |  | Full range |  |  | 300 |  |

$\dagger$ Full range is $-40^{\circ} \mathrm{C}$ to $125^{\circ} \mathrm{C}$.
switching characteristics at recommended operating conditions, $\mathrm{V}_{\mathrm{Cc}}=2.7 \mathrm{~V}, 5 \mathrm{~V}$, 15 V (unless otherwise noted)

|  | PARAMETER | TEST CONDITIONS |  | $\mathrm{T}_{\text {A }}$ | MIN TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ${ }^{\text {t }}$ (PLH) | Propagation response time, low-to-high-level output | $\begin{aligned} & \mathrm{f}=10 \mathrm{kHz}, \\ & \mathrm{~V}_{\mathrm{STEP}}=100 \mathrm{mV}, \\ & \mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}, \\ & \mathrm{~V}_{\mathrm{CC}}=2.7 \mathrm{~V} \end{aligned}$ | Overdrive $=2 \mathrm{mV}$ | $25^{\circ} \mathrm{C}$ | 240 |  | $\mu \mathrm{S}$ |
|  |  |  | Overdrive $=10 \mathrm{mV}$ |  | 64 |  |  |
|  |  |  | Overdrive $=50 \mathrm{mV}$ |  | 36 |  |  |
| ${ }^{\text {t }}$ (PHL) | Propagation response time, high-to-low-level output |  | Overdrive $=2 \mathrm{mV}$ | $25^{\circ} \mathrm{C}$ | 167 |  |  |
|  |  |  | Overdrive $=10 \mathrm{mV}$ |  | 67 |  |  |
|  |  |  | Overdrive $=50 \mathrm{mV}$ |  | 37 |  |  |
| $\mathrm{tr}_{\mathrm{r}}$ | Rise time | $\mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}$, | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ | $25^{\circ} \mathrm{C}$ | 7 |  | $\mu \mathrm{s}$ |
| tf | Fall time | $\mathrm{C}_{\mathrm{L}}=10 \mathrm{pF}$, | $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ | $25^{\circ} \mathrm{C}$ | 9 |  | $\mu \mathrm{s}$ |

NOTE: The propagation response time specified is the interval between the input step function and the instant when the output crosses 1.4 V . Propagation responses are longer at higher supply voltages, refer to Figure 18 through Figure 36 for further details.

## TYPICAL CHARACTERISTICS

Table of Graphs

|  |  |  | FIGURE |
| :---: | :---: | :---: | :---: |
| $\mathrm{V}_{10}$ | Input offset voltage | vs Common-mode input voltage | 1,2 |
|  |  | vs Free-air temperature | 3, 5, 7 |
| IIB | Input bias current | vs Common-mode input voltage | 4, 6 |
|  |  | vs Free-air temperature | 3, 5, 7 |
| 1 O | Input offset current | vs Common-mode input voltage | 4,6 |
|  |  | vs Supply voltage | 8 |
| ICC | Supply current | vs Free-air temperature | 9 |
| Amplifie |  |  |  |
| CMRR | Common-mode rejection ratio | vs Frequency | 10 |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage | vs High-level output current | 11, 13 |
| $\mathrm{V}_{\mathrm{OL}}$ | Low-level output voltage | vs Low-level output current | 12, 14 |
| $\mathrm{V}_{\mathrm{O}}(\mathrm{PP})$ | Output voltage, peak-to-peak | vs Frequency | 15 |
| PSRR | Power supply rejection ratio | vs Frequency | 16 |
|  | Voltage noise over a 10 Second Period |  | 17 |
| $\phi_{\text {m }}$ | Phase margin | vs Capacitive load | 18 |
| AVD | Differential voltage gain | vs Frequency | 19 |
|  | Phase | vs Frequency | 19 |
|  | Gain-bandwidth product | vs Supply voltage | 20 |
| SR | Slew rate | vs Free-air temperature | 21 |
|  | Large-signal follower pulse response |  | 22 |
|  | Small-signal follower pulse response |  | 23 |
|  | Large-signal inverting pulse response |  | 24 |
|  | Small-signal inverting pulse response |  | 25 |
| Compar |  |  |  |
| $\mathrm{V}_{\mathrm{OH}}$ | High-level output voltage | vs High-level output current | 26, 28 |
| $\mathrm{V}_{\mathrm{OL}}$ | Low-level output voltage | vs Low-level output current | 27, 29 |
|  | Output rise/fall time | vs Supply voltage | 30 |
|  | Low-to-high level output response for various input overdrives |  | 31, 33, 35 |
|  | High-to-low level output response for various input overdrives |  | 32, 34, 36 |

## AMPLIFIER AND COMPARATOR TYPICAL CHARACTERISTICS



## AMPLIFIER TYPICAL CHARACTERISTICS



## AMPLIFIER TYPICAL CHARACTERISTICS



SMALL-SIGNAL FOLLOWER PULSE RESPONSE


Figure 23

SMALL-SIGNAL INVERTING PULSE RESPONSE



Figure 24

## COMPARATOR TYPICAL CHARACTERISTICS



Figure 26

HIGH-LEVEL OUTPUT VOLTAGE
vs
HIGH-LEVEL OUTPUT CURRENT


Figure 28

LOW-LEVEL OUTPUT VOLTAGE
vs LOW-LEVEL OUTPUT CURRENT


Figure 27

LOW-LEVEL OUTPUT VOLTAGE
VS


Figure 29

OUTPUT RISE/FALL TIME
vs
SUPPLY VOLTAGE


Figure 30

## TYPICAL CHARACTERISTICS



Figure 31


Figure 33


Figure 35


Figure 32
HIGH-TO-LOW LEVEL OUTPUT RESPONSE


Figure 34
HIGH-TO-LOW LEVEL OUTPUT RESPONSE

## FOR VARIOUS INPUT OVERDRIVES



Figure 36

## APPLICATION INFORMATION

## reverse battery protection

The TLV2702/4 are protected against reverse battery voltage up to 18 V . When subjected to reverse battery condition the supply current is typically less than 100 nA at $25^{\circ} \mathrm{C}$ (inputs grounded and outputs open). This current is determined by the leakage of 6 Schottky diodes and will therefore increase as the ambient temperature increases.

When subjected to reverse battery conditions and negative voltages applied to the inputs or outputs, the input ESD structure will turn on-this current should be limited to less than 10 mA . If the inputs or outputs are referred to ground, rather than midrail, no extra precautions need be taken.

## common-mode input range

The TLV2702/4 has rail-rail input and outputs. For common-mode inputs from -0.1 V to $\mathrm{V}_{\mathrm{CC}}-0.8 \mathrm{~V}$ a PNP differential pair will provide the gain.

For inputs between $\mathrm{V}_{\mathrm{CC}}-0.8 \mathrm{~V}$ and $\mathrm{V}_{\mathrm{CC}}$, two NPN emitter followers buffering a second PNP differential pair provide the gain. This special combination of NPN/PNP differential pair enables the inputs to be taken 5 V above the rails; because as the inputs go above $\mathrm{V}_{\mathrm{CC}}$, the NPNs switch from functioning as transistors to functioning as diodes. This will lead to an increase in input bias current. The second PNP differential pair continues to function normally as the inputs exceed $\mathrm{V}_{\mathrm{CC}}$.
The TLV2702/4 has a negative common-input range that exceeds ground by 100 mV . If the inputs are taken much below this, reduced open loop gain will be observed with the ultimate possibility of phase inversion.

## offset voltage

The output offset voltage, ( $\mathrm{V}_{\mathrm{OO}}$ ) is the sum of the input offset voltage $\left(\mathrm{V}_{\mathrm{IO}}\right)$ and both input bias currents ( $\mathrm{I}_{\mathrm{IB}}$ ) times the corresponding gains. The following schematic and formula can be used to calculate the output offset voltage.


Figure 37. Output Offset Voltage Model

## APPLICATION INFORMATION

## general configurations

When receiving low-level signals, limiting the bandwidth of the incoming signals into the system is often required. The simplest way to accomplish this is to place an RC filter at the noninverting terminal of the amplifier (see Figure 38).


Figure 38. Single-Pole Low-Pass Filter
If even more attenuation is needed, a multiple pole filter is required. The Sallen-Key filter can be used for this task. For best results, the amplifier should have a bandwidth that is 8 to 10 times the filter frequency bandwidth. Failure to do this can result in phase shift of the amplifier.


$$
\mathbf{R} 1=\mathbf{R} 2=\mathbf{R}
$$

$$
\mathrm{C} 1=\mathrm{C} 2=\mathrm{C}
$$

$$
Q=\text { Peaking Factor }
$$

$$
\text { (Butterworth } \mathbf{Q}=0.707 \text { ) }
$$

$$
\mathrm{f}_{-3 \mathrm{~dB}}=\frac{1}{2 \pi \mathrm{RC}}
$$

$$
R_{G}=\frac{R_{F}}{\left(2-\frac{1}{Q}\right)}
$$

Figure 39. 2-Pole Low-Pass Sallen-Key Filter

## APPLICATION INFORMATION

## circuit layout considerations

To achieve the levels of high performance of the TLV270x, follow proper printed-circuit board design techniques. A general set of guidelines is given in the following.

- Ground planes-It is highly recommended that a ground plane be used on the board to provide all components with a low inductive ground connection. However, in the areas of the amplifier inputs and output, the ground plane can be removed to minimize the stray capacitance.
- Proper power supply decoupling-Use a $6.8-\mu \mathrm{F}$ tantalum capacitor in parallel with a $0.1-\mu \mathrm{F}$ ceramic capacitor on each supply terminal. It may be possible to share the tantalum among several amplifiers depending on the application, but a $0.1-\mu \mathrm{F}$ ceramic capacitor should always be used on the supply terminal of every amplifier. In addition, the $0.1-\mu \mathrm{F}$ capacitor should be placed as close as possible to the supply terminal. As this distance increases, the inductance in the connecting trace makes the capacitor less effective. The designer should strive for distances of less than 0.1 inches between the device power terminals and the ceramic capacitors.
- Sockets-Sockets can be used but are not recommended. The additional lead inductance in the socket pins will often lead to stability problems. Surface-mount packages soldered directly to the printed-circuit board is the best implementation.
- Short trace runs/compact part placements-Optimum high performance is achieved when stray series inductance has been minimized. To realize this, the circuit layout should be made as compact as possible, thereby minimizing the length of all trace runs. Particular attention should be paid to the inverting input of the amplifier. Its length should be kept as short as possible. This will help to minimize stray capacitance at the input of the amplifier.
- Surface-mount passive components-Using surface-mount passive components is recommended for high performance amplifier circuits for several reasons. First, because of the extremely low lead inductance of surface-mount components, the problem with stray series inductance is greatly reduced. Second, the small size of surface-mount components naturally leads to a more compact layout thereby minimizing both stray inductance and capacitance. If leaded components are used, it is recommended that the lead lengths be kept as short as possible.


## general power dissipation considerations

For a given $\theta_{\mathrm{JA}}$, the maximum power dissipation is shown in Figure 40 and is calculated by the following formula:

$$
P_{D}=\left(\frac{T_{M A X}{ }^{-T} A}{\theta_{J A}}\right)
$$

Where:
$P_{D}=$ Maximum power dissipation of TLV270x IC (watts)
$\mathrm{T}_{\mathrm{MAX}}=$ Absolute maximum junction temperature $\left(150^{\circ} \mathrm{C}\right)$
$\mathrm{T}_{\mathrm{A}}=$ Free-ambient air temperature $\left({ }^{\circ} \mathrm{C}\right)$
$\theta_{\mathrm{JA}}=\theta_{\mathrm{JC}}+\theta_{\mathrm{CA}}$
$\theta_{\mathrm{JC}}=$ Thermal coefficient from junction to case
$\theta_{\mathrm{CA}}=$ Thermal coefficient from case to ambient air ( ${ }^{\circ} \mathrm{C} / \mathrm{W}$ )

MAXIMUM POWER DISSIPATION
vs
FREE-AIR TEMPERATURE


NOTE A: Results are with no air flow and using JEDEC Standard Low-K test PCB.
Figure 40. Maximum Power Dissipation vs Free-Air Temperature

## APPLICATION INFORMATION

## amplifier macromodel information

Macromodel information provided was derived using Microsim Parts ${ }^{\text {TM }}$ Release 8, the model generation software used with Microsim PSpice ${ }^{\text {TM }}$. The Boyle macromodel (see Note 2) and subcircuit in Figure 41 are generated using the TLV270x typical electrical and operating characteristics at $T_{A}=25^{\circ} \mathrm{C}$. Using this information, output simulations of the following key parameters can be generated to a tolerance of $20 \%$ (in most cases):

- Maximum positive output voltage swing
- Maximum negative output voltage swing
- Slew rate
- Quiescent power dissipation
- Input bias current
- Open-loop voltage amplification
- Unity-gain frequency
- Common-mode rejection ratio
- Phase margin
- DC output resistance
- AC output resistance
- Short-circuit output current limit

NOTE 3: G. R. Boyle, B. M. Cohn, D. O. Pederson, and J. E. Solomon, "Macromodeling of Integrated Circuit Operational Amplifiers", IEEE Journal of Solid-State Circuits, SC-9, 353 (1974).




Figure 41. Boyle Macromodels and Subcircuit

PSpice and Parts are trademarks of MicroSim Corporation.

## MECHANICAL DATA <br> D (R-PDSO-G**) <br> PLASTIC SMALL-OUTLINE PACKAGE <br> 14 PIN SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion, not to exceed $0.006(0,15)$.

## MECHANICAL INFORMATION

DGK (R-PDSO-G8)
PLASTIC SMALL-OUTLINE PACKAGE


NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion.
D. Falls within JEDEC MO-187

## MECHANICAL INFORMATION

N (R-PDIP-T**)
PLASTIC DUAL-IN-LINE PACKAGE
16 PINS SHOWN


NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS-001 (20-pin package is shorter than MS-001).

## MECHANICAL INFORMATION

P (R-PDIP-T8)
PLASTIC DUAL-IN-LINE PACKAGE


4040082/B 03/95

NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS-001

## MECHANICAL INFORMATION

PW (R-PDSO-G**)
PLASTIC SMALL-OUTLINE PACKAGE
14 PINS SHOWN


| DIM PINS $^{* *}$ | $\mathbf{8}$ | $\mathbf{1 4}$ | $\mathbf{1 6}$ | $\mathbf{2 0}$ | $\mathbf{2 4}$ | $\mathbf{2 8}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A MAX | 3,10 | 5,10 | 5,10 | 6,60 | 7,90 | 9,80 |
| A MIN | 2,90 | 4,90 | 4,90 | 6,40 | 7,70 | 9,60 |

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15 .
D. Falls within JEDEC MO-153

## PACKAGING INFORMATION

| Orderable Device | Status ${ }^{(1)}$ | Package <br> Type | Package <br> Drawing | Pins Package <br> Qty | Eco Plan ${ }^{(2)}$ | Lead/Ball Finish | MSL Peak Temp ${ }^{(3)}$ |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TLV2702ID | ACTIVE | SOIC | D | 8 | 75 |  <br> no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TLV2702IDG4 | ACTIVE | SOIC | D | 8 | 75 |  <br> no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TLV2702IDGK | ACTIVE | MSOP | DGK | 8 | 80 |  <br> no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TLV2702IDGKG4 | ACTIVE | MSOP | DGK | 8 | 80 |  <br> no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TLV2702IDGKR | ACTIVE | MSOP | DGK | 8 | 2500 |  <br> no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TLV2702IDGKRG4 | ACTIVE | MSOP | DGK | 8 | 2500 |  <br> no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TLV2702IP | ACTIVE | PDIP | P | 8 | 50 | Pb-Free <br> (RoHS) | CU NIPDAU | N/A for Pkg Type |
| TLV2702IPE4 | ACTIVE | PDIP | P | 8 | 50 | Pb-Free <br> (RoHS) | CU NIPDAU | N/A for Pkg Type |
| TLV2704ID | ACTIVE | SOIC | D | 14 | 50 |  <br> no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| TLV2704IDG4 | ACTIVE | SOIC | D | 14 | 50 |  <br> no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but Tl does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS \& no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb -Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb -Free products are suitable for use in specified lead-free processes.
Pb -Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS \& no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine ( Br ) and Antimony (Sb) based flame retardants ( Br or Sb do not exceed $0.1 \%$ by weight in homogeneous material)
${ }^{(3)}$ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer:The information provided on this page represents Tl's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## TAPE AND REEL INFORMATION



QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


| Device | Package Type | Package Drawing | Pins | SPQ |  | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | $\begin{gathered} \text { P1 } \\ (\mathrm{mm}) \end{gathered}$ | $\begin{gathered} \mathrm{W} \\ (\mathrm{~mm}) \end{gathered}$ | Pin1 <br> Quadrant |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TLV2702IDGKR | MSOP | DGK | 8 | 2500 | 330.0 | 12.4 | 5.3 | 3.4 | 1.4 | 8.0 | 12.0 | Q1 |


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TLV2702IDGKR | MSOP | DGK | 8 | 2500 | 358.0 | 335.0 | 35.0 |

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries（TI）reserve the right to make corrections，modifications，enhancements，improvements， and other changes to its products and services at any time and to discontinue any product or service without notice．Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete．All products are sold subject to Tl＇s terms and conditions of sale supplied at the time of order acknowledgment．
TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI＇s standard warranty．Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty．Except where mandated by government requirements，testing of all parameters of each product is not necessarily performed．
TI assumes no liability for applications assistance or customer product design．Customers are responsible for their products and applications using TI components．To minimize the risks associated with customer products and applications，customers should provide adequate design and operating safeguards．
TI does not warrant or represent that any license，either express or implied，is granted under any TI patent right，copyright，mask work right， or other TI intellectual property right relating to any combination，machine，or process in which TI products or services are used．Information published by TI regarding third－party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof．Use of such information may require a license from a third party under the patents or other intellectual property of the third party，or a license from TI under the patents or other intellectual property of TI ．
Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties，conditions，limitations，and notices．Reproduction of this information with alteration is an unfair and deceptive business practice．TI is not responsible or liable for such altered documentation．Information of third parties may be subject to additional restrictions．
Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice．TI is not responsible or liable for any such statements．
TI products are not authorized for use in safety－critical applications（such as life support）where a failure of the TI product would reasonably be expected to cause severe personal injury or death，unless officers of the parties have executed an agreement specifically governing such use．Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications，and acknowledge and agree that they are solely responsible for all legal，regulatory and safety－related requirements concerning their products and any use of TI products in such safety－critical applications，notwithstanding any applications－related information or support that may be provided by TI．Further，Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety－critical applications．
TI products are neither designed nor intended for use in military／aerospace applications or environments unless the TI products are specifically designated by TI as military－grade or＂enhanced plastic．＂Only products designated by TI as military－grade meet military specifications．Buyers acknowledge and agree that any such use of TI products which TI has not designated as military－grade is solely at the Buyer＇s risk，and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use．
TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO／TS 16949 requirements．Buyers acknowledge and agree that，if they use any non－designated products in automotive applications， TI will not be responsible for any failure to meet such requirements．
Following are URLs where you can obtain information on other Texas Instruments products and application solutions：

| Products |  | Applications |  |
| :---: | :---: | :---: | :---: |
| Amplifiers | amplifier．ti．com | Audio | www．ti．com／audio |
| Data Converters | dataconverter．ti．com | Automotive | www．ti．com／automotive |
| DLP® Products | www．dlp．com | Broadband | www．ticom／broadband |
| DSP | asp．ti．com | Digital Control | www．ti．com／digitalcontro |
| Clocks and Timers | www．ti．com／clocks | Medical | www．ti．com／medica |
| Interface | nterface．ti．com | Military | www．ti．com／military |
| Logic | ogic．ti．com | Optical Networking | www．ti．com／opticalnetwork |
| Power Mgmt | bower．ti．com | Security | www．ti．com／security |
| Microcontrollers | microcontroller．ti．com | Telephony | www．ti．com／telephony |
| RFID | www．ti－rfid．com | Video \＆Imaging | www．ti．com／vided |
| RF／IF and ZigBee® Solutions | www．ti．com／lpr | Wireless | www．ti．com／wireless |

Mailing Address：Texas Instruments，Post Office Box 655303，Dallas，Texas 75265
Copyright © 2009，Texas Instruments Incorporated

